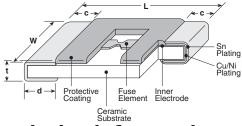




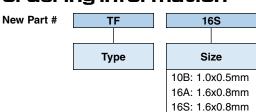
# thin film chip fuse



## dimensions and construction



# ordering information



Fusing Characteristic N: Normal blow T: Anti pulse (16A only)

1.25 Rated Termination Material Current Reference T: Sn rating chart

#### features

- Small, lightweight design
- Special manufacturing method stabilizing fusing characteristics and occupying less area
- Low power consumption and less voltage drop due to low internal resistance
- Suitable for overcurrent protection of circuit block in electronic devices
- Suitable for flow and reflow soldering
- Marking: Black body color with white marking: TF10BN, TF10SN; white marking: TF10AT
- Products with lead-free terminations meet EU RoHS and China RoHS requirements

Туре	Dimensions inches (mm)					
(Inch Size Code)	L	W	С	d	t	
TF10BN (0402)	.04±.004 (1.0±0.1)	.02±.002 (0.5±0.05)	.008±.004 (0.2±0.1)	.01±.004 (0.25±0.1)	.015±.002 (0.4±0.05)	
TF16AT (0603)	.063±.004 (1.6±0.1)	.031±.003 (0.8±0.08)	.012±.004 (0.3±0.1)	.012±.004 (0.3±0.1)	.018±.002 (0.45±0.05)	
TF16SN (0603)	.063±.008 (1.6±0.2)	.031±.004 (0.8±0.1)	.012±.004 (0.3±0.1)	.012±.004 (0.3±0.1)	.015+ +.004 002 (0.4+ +0.1 -0.05)	

#### **Packaging**

ΤE

TB: 2mm pitch punched paper (TF10BN only, 10,000 pieces/reel)

TD: 4mm pitch punched paper (TF16 only, 5,000 pieces/reel)

	Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
	TF10BN0.20	Α	0.20A		1990	24V	+70°C	-55°C to +125°C
	TF10BN0.25	С	0.25A		1270			
	TF10BN0.315	D	0.315A		850			
	TF10BN0.50	F	0.50A	Open within	320			
	TF10BN0.63		0.63A	5 sec. at 200%	200			
	TF10BN0.80	K	0.80A	rated current	135			
	TF10BN1.00	L	1.00A	(Refer to Fusing	115			
	TF10BN1.25	M	1.25A	Characteristics graph)	90			
	TF10BN1.60	N	1.60A		58			
	TF10BN2.00	S	2.00A		42			
	TF10BN2.50	Т	2.50A		35			
NEW	TF10BN3.00	V	3.00A		30			
	TF16AT0.25	С	0.25A		498			
	TF16AT0.315	D	0.315A		384			
	TF16AT0.50	F	0.50A	Open within	198	32V	+70°C	-55°C to +125°C
	TF16AT0.63	1	0.63A	5 sec. at 200%	143			
	TF16AT0.80	K	0.80A	rated current	120			
	TF16AT1.00	L	1.00A	(Refer to Fusing	94			
	TF16AT1.25	М	1.25A	Characteristics	73			
	TF16AT1.60	N	1.60A	graph)	59			
ļ	TF16AT2.00	S	2.00A		42			
	TF16AT2.50	T	2.50A		32			

For further information on packaging, please refer to Appendix A.

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

1/03/13





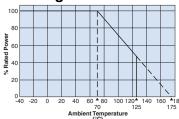
# thin film chip fuse

## applications and ratings (continued)

Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
TF16AT3.15	U	3.15A	Open within 5 sec. at	24			-55°C
TF16AT4.00	X	4.00A	200% rated current (Refer to Fusing	17	32V	+70°C	to +125°C
TF16AT5.00	Υ	5.00A	Characteristics graph)	14			
TF16SN0.20	Α	0.20A		1500			
TF16SN0.25	С	0.25A		960			
TF16SN0.315	D	0.315A		600	32V	+70°C	-40°C to +125°C
TF16SN0.40	Н	0.40A	Open within 1 sec. at 200% rated current	440			
TF16SN0.50	F	0.50A		300			
TF16SN0.63	l	0.63A		190			
TF16SN0.70	J	0.70A	(Refer to Fusing	170			
TF16SN0.80	K	0.80A	Characteristics	135			
TF16SN1.00	L	1.00A	graph)	103			
TF16SN1.25	M	1.25A		78			
TF16SN1.60	N	1.60A		58			
TF16SN2.00	S	2.00A		47			
TF16SN2.50	T	2.50A		38			
TF16SN3.15	U	3.15A		28			

## environmental applications

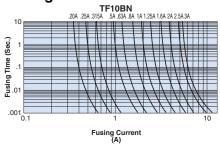
### **Derating Curve**

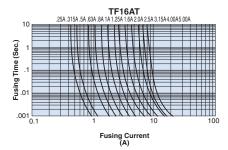


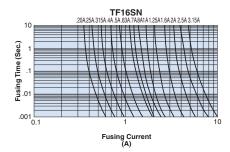
Stationary Current: Regard the peak of stationary current waveform as stationary current value when the stationary current is repeated pulse.

Temperature Derating: Rated current needs to be derated if used at an ambient temperature 70°C or above. Refer to the derating coefficient on the right figure.

### **Fusing Characteristics**







## **Performance Characteristics**

	Requirement				
Parameter	Limit	Typical	Test Method		
Clearing Time	Within 1 second	_	200% of rated voltage shall be carried		
Bending Test	No mechanical damages	_	Distance between holding points: 90mm, Bending: 3mm, 1 time (BN, AT), 2mm, 1 time (SN)		
Resistance to Solder Heat	±10%	±4.5%	260°C ± 5°C, 10 seconds ± 0.5 <sup>-1</sup> <sub>-0</sub> second		
Solderability	95% coverage minimum	_	230°C ± 5°C, 3 seconds ± 0.5 second		
Load Life	±10%	±8.0% ±4.5%(16SN)	70°C ± 2°C, 1000 hours, rated current x 100%, 1.5 hr ON, 0.5 hr OFF cycle		
Load Life Moisture	±10%	±4.5%	40°C ± 2°C, 90 - 95% RH, 1000 hours, rated current x 100%, 1.5 hr ON, 0.5 hr OFF cycle		
Rapid Change of Temperature	±10%	±4.0%	-40°C (30 minutes), +125°C (30 minutes), 10 cycles		
Resistance to Solvent	No evidence of damages to protective coating and marking	_	Conforming to MIL-STD-202F		
Residual Resistance	10kΩ and more	_	Measure DC resistance after fusing		

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